

RCX511N25 Nch 250V 51A Power MOSFET

V _{DSS}	250V
R _{DS(on)} (Max.)	$65 m\Omega$
I _D	51A
P _D	84W

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

Application

Switching Power Supply

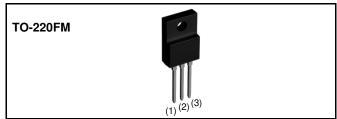
Automotive Motor Drive

Automotive Solenoid Drive

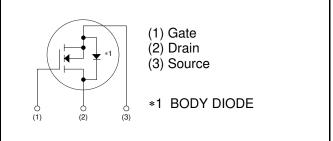
●Absolute maximum ratings(T_a = 25°C)

Value Parameter Symbol Unit V_{DSS} 250 V Drain - Source voltage I_{D}^{*1} $T_c = 25^{\circ}C$ ±51 А Continuous drain current I_D^{*1} $T_{c} = 100^{\circ}C$ ±27.7 А *2 204 Pulsed drain current I_{D,pulse} А $\mathsf{V}_{\mathsf{GSS}}$ V Gate - Source voltage ±30 *3 Avalanche energy, single pulse E_{AS} 197.9 mJ *3 Avalanche current 25.5 А I_{AR} $T_c = 25^{\circ}C$ P_{D} W 84 Power dissipation $T_a = 25^{\circ}C$ P_{D} 2.23 W Ti 150 °C Junction temperature T_{stg} -55 to +150 °C Range of storage temperature

Outline



Inner circuit



Packaging specifications

	Packaging	Bulk
Туре	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	500
	Taping code	-
	Marking	RCX511N25

•Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}	-	-	1.48	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	56	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	250	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 250V, V _{GS} = 0V T _i = 25°C	-	-	10	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	100	nA
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_D = 1mA$	3.0	-	5.0	V
	${\sf R}_{\sf DS(on)}$ *4	$V_{GS} = 10V, I_D = 25.5A$	-	48	65	
Static drain - source on - state resistance		$V_{GS} = 10V, I_D = 25.5A$ $T_j = 125^{\circ}C$	-	110	155	mΩ
Forward transfer admittance	g_{fs}	$V_{DS} = 10V, I_{D} = 25.5A$	15	30	-	S

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•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	7000	-	
Output capacitance	C _{oss}	V _{DS} = 25V	-	350	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	200	-	
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 125V, V_{GS} = 10V$	-	65	-	
Rise time	t _r *4	I _D = 25.5A	-	300	-	20
Turn - off delay time	t _{d(off)} *4	$R_L = 4.7\Omega$	-	170	-	ns
Fall time	t _f *4	$R_G = 10\Omega$	-	210	-	

•Gate Charge characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*4}	$V_{DD} \simeq 125V$	-	120	-	
Gate - Source charge	Q _{gs} ^{*4}	I _D = 51A	-	40	-	nC
Gate - Drain charge	${\sf Q_{gd}}^{*4}$	$V_{GS} = 10V$	-	40	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 125V, \ I_D = 51A$	-	6.5	-	V

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous source current	I_{S}^{*1}	T _c = 25°C	-	-	51	А
Pulsed source current	I_{SM} *2	$r_{c} = 25.0$	-	-	204	А
Forward voltage	V_{SD} *4	$V_{GS} = 0V, I_{S} = 51A$	-	-	1.5	V
Reverse recovery time	t _{rr} *4	I _S = 25.5A	-	175	-	ns
Reverse recovery charge	Q_{rr}^{*4}	di/dt = 100A/µs	-	1100	-	nC

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD} = 50V, Rg = 25Ω, starting T_j = 25°C

*4 Pulsed

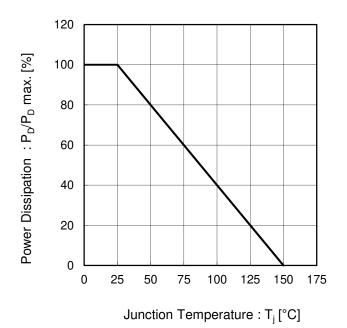


Fig.1 Power Dissipation Derating Curve

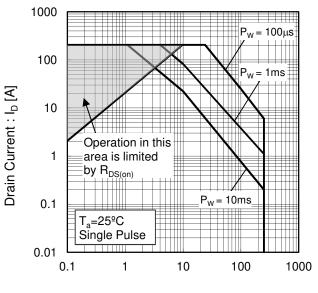
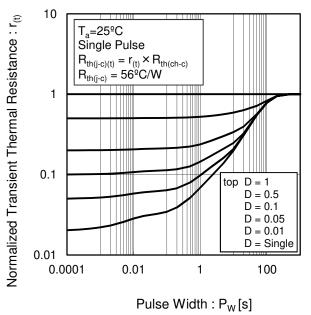


Fig.2 Maximum Safe Operating Area

Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



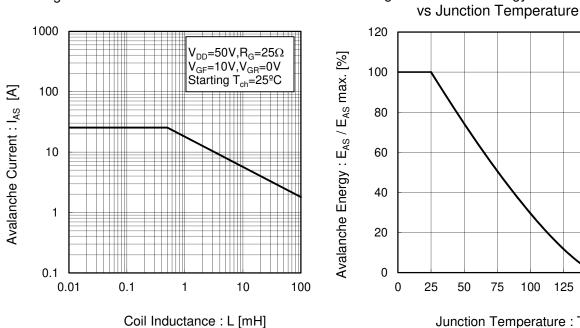


Fig.4 Avalanche Current vs Inductive Load

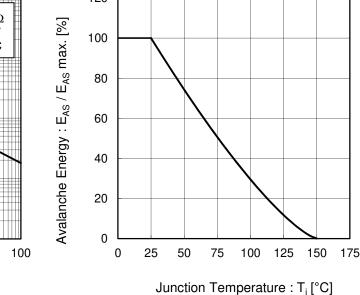
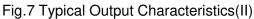
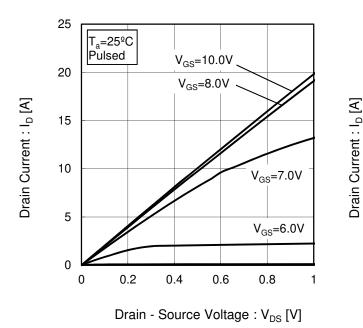
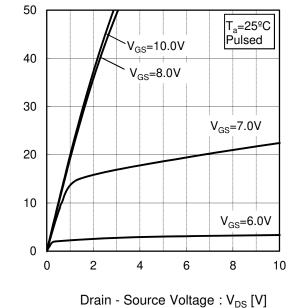


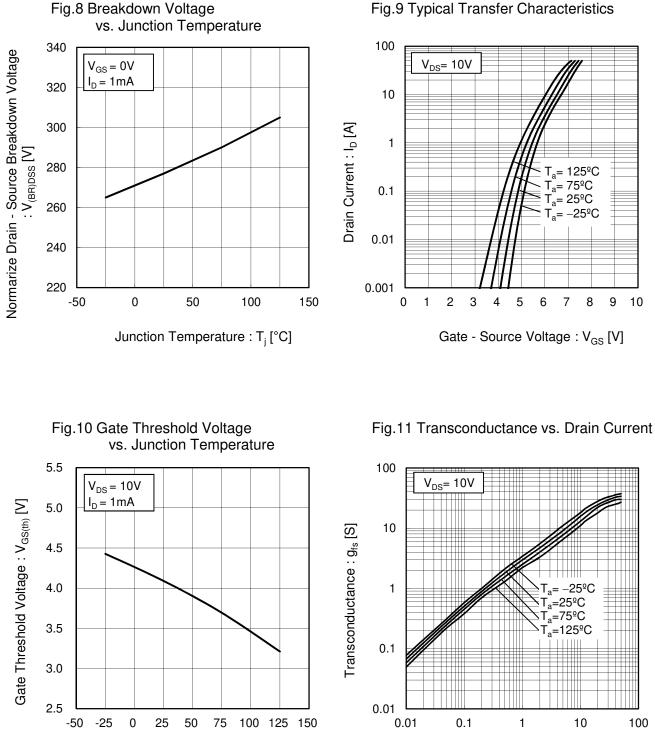
Fig.5 Avalanche Energy Derating Curve

Fig.6 Typical Output Characteristics(I)





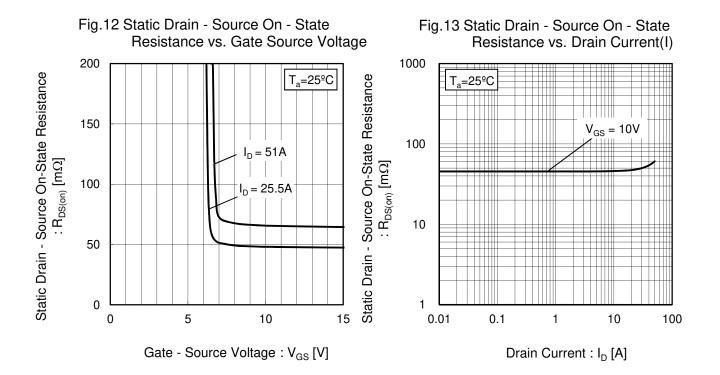


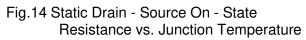


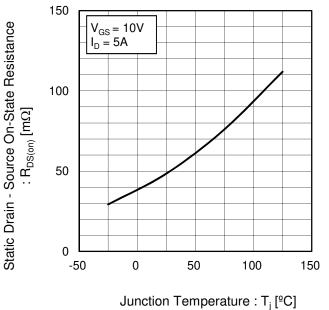
Drain Current : I_D [A]

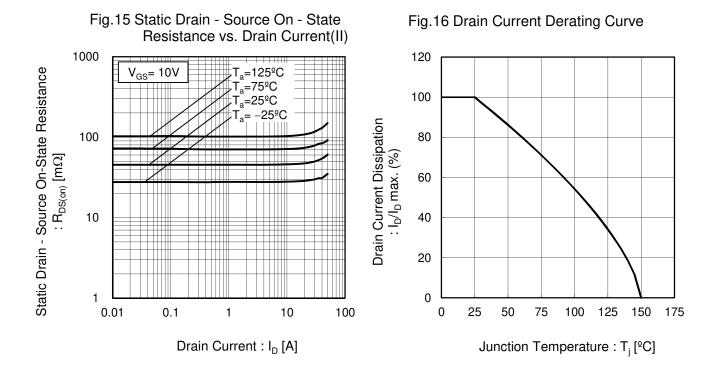
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Junction Temperature : T_i [°C]









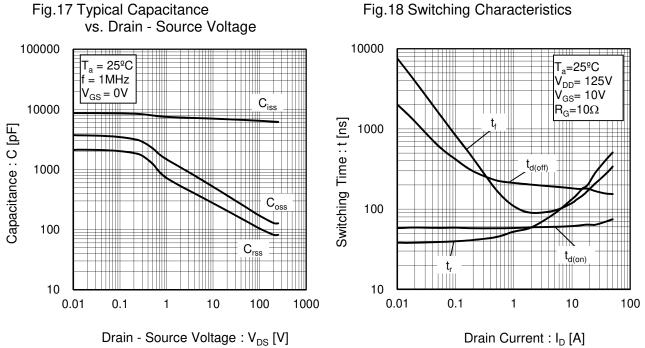


Fig.19 Dynamic Input Characteristics

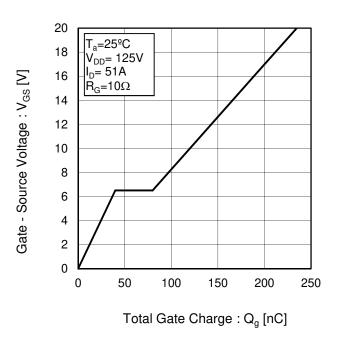
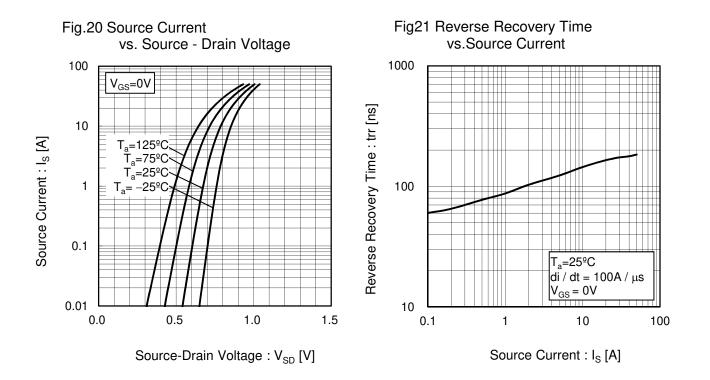


Fig.18 Switching Characteristics



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

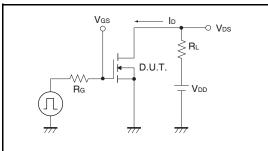


Fig.2-1 Gate Charge Measurement Circuit

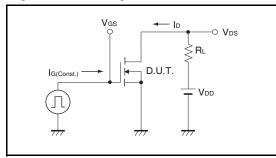


Fig.3-1 Avalanche Measurement Circuit

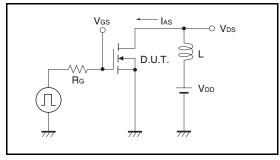


Fig.1-2 Switching Waveforms

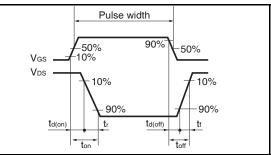


Fig.2-2 Gate Charge Waveform

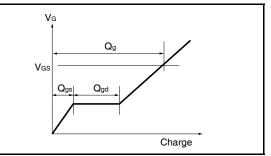
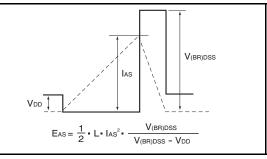
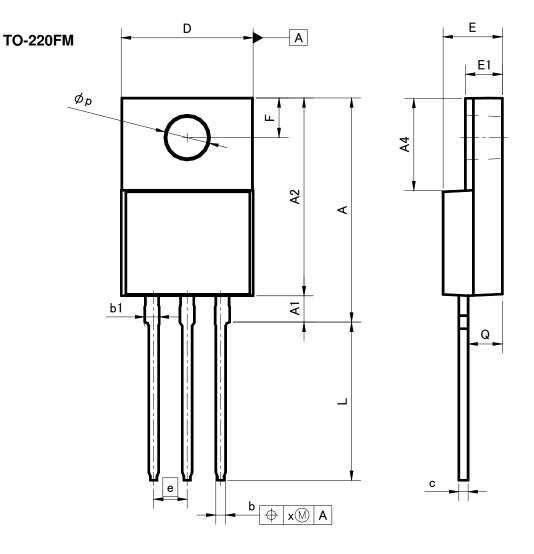


Fig.3-2 Avalanche Waveform



•Dimensions (Unit : mm)



DIM	DIM		INC	HES
DIM	MIN	MAX	MIN	MAX
A	16.60	17.60	0.654	0.693
A1	1.80	2.20	0.071	0.087
A2	14.80	15.40	0.583	0.606
A4	6.80	7.20	0.268	0.283
b	0.70	0.85	0.028	0.033
b1	1.10	1.50	0.043	0.059
с	0.70	0.85	0.028	0.033
D	9.90	10.30	0.39	0.406
E	4.40	4.80	0.173	0.189
е	2.	54	0.	10
E1	2.70	3.00	0.106	0.118
F	2.80	3.20	0.11	0.126
L	11.50	12.50	0.453	0.492
р	3.00	3.40	0.118	0.134
Q	2.10	3.10	0.083	0.122
х	_	0.381	_	0.015

Dimension in mm/inches

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(Note1) Medical Equipment Classification of the S	pecific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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